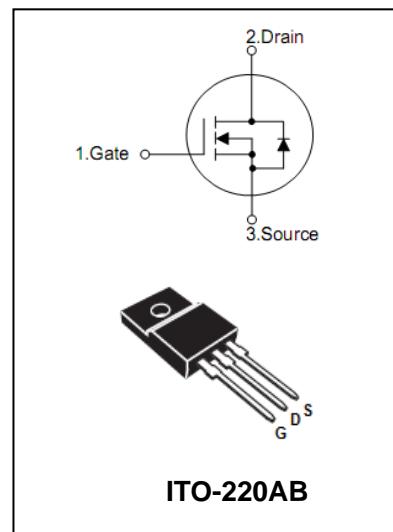


**N-Channel Power MOSFET****BL15N30F****FEATURES**

- RDS(on) = 240 m (Typ.) @ VGS = 10 V, ID = 7.5 A
- Low Gate Charge (Typ. 28 nC)
- Low Crss (Typ. 17 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- RoHS Compliant

**APPLICATIONS**

- Lighting
- Uninterruptible Power Supply

**MOSFET Maximum Ratings**  $T_C = 25^\circ\text{C}$  unless otherwise noted\*

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-Source Voltage	300	V
$V_{GS}$	Gate -Source Voltage	$\pm 30$	V
$I_D$	Drain Current Continuous at $T_C=25^\circ\text{C}$ Continuous at $T_C=100^\circ\text{C}$	15 9	A
$I_{DM}$	Drain Current(pulsed)Note1	60	A
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	731	mJ
$E_{AR}$	Repetitive Avalanche Energy (Note 1)	17	mJ
IAR	Avalanche Current (Note 1)	15	A
dv/dt	Peak Diode Recovery dv/dt (Note 3)	15	V/ns
$P_D$	Power Dissipation $T_C=25^\circ\text{C}$ Derate above $25^\circ\text{C}$	170 1.45	W W/ $^\circ\text{C}$
$R_{\theta JA}$	Thermal Resistance,Junction-to-Ambient	62.5	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance,Junction-to-Case	0.7	$^\circ\text{C}/\text{W}$
$T_j$ $T_{stg}$	Junction and StorageTemperature Range	-55 to +150	$^\circ\text{C}$

**N-Channel Power MOSFET****BL15N30F**ELECTRICAL CHARACTERISTICS @  $T_a=25^\circ C$  unless otherwise specified

Parameter	Symbol	Test conditions	MIN	TYP	MAX	UNIT
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	300	-	-	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=300V, V_{GS}=0V$	-	-	1	$\mu A$
Gate- Source Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 30V$	-	-	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.5	-	5.0	V
Static drain-Source On-State resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=7.5A$	-	0.24	0.3	$\Omega$
Drain-Source Diode Forward Voltage	$V_{SD}$	$I_{SD}=15A, V_{GS}=0$	-	-	1.4	V
Input Capacitance	$C_{ISS}$	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$	-	1310	1750	pF
Output Capacitance	$C_{OSS}$		-	210	280	pF
Reverse Transfer Capacitance	$C_{RSS}$		-	17	25	pF
Turn-On Delay Time	$t_{D(ON)}$	$V_{DD}=200V, I_D=15A, R_G=25\Omega$	-	26	62	ns
Rise Time	$t_R$		-	55	120	ns
Turn-Off Delay Time	$t_{D(OFF)}$		-	72	154	ns
Fall Time	$t_F$		-	40	90	ns
Total Gate Charge	$Q_g$	$V_{DS}=320V, V_{GS}=10V, I_D=15A$	-	28	36	nC
Gate-source Charge	$Q_{gs}$		-	8		nC
Gate-drain Charge	$Q_{gd}$		-	12		nC
Maximum Body-Diode Continuous Current	$I_S$		-	-	15	A
Maximum Body-Diode Pulsed Current	$I_{SM}$		-	-	60	A

Notes: 1: Repetitive Rating: Pulse width limited by maximum junction temperature

2:  $L = 6.5mH, I_{AS} = 15A, V_{DD} = 50V, R_G = 25\Omega$ , Starting  $T_J = 25^\circ C$ 3:  $I_{SD} = 15A, \frac{dI}{dt} = 200A/\mu s, V_{DD} = BVDSS$ , Starting  $T_J = 25^\circ C$ 

4: Essentially Independent of Operating Temperature Typical Characteristics

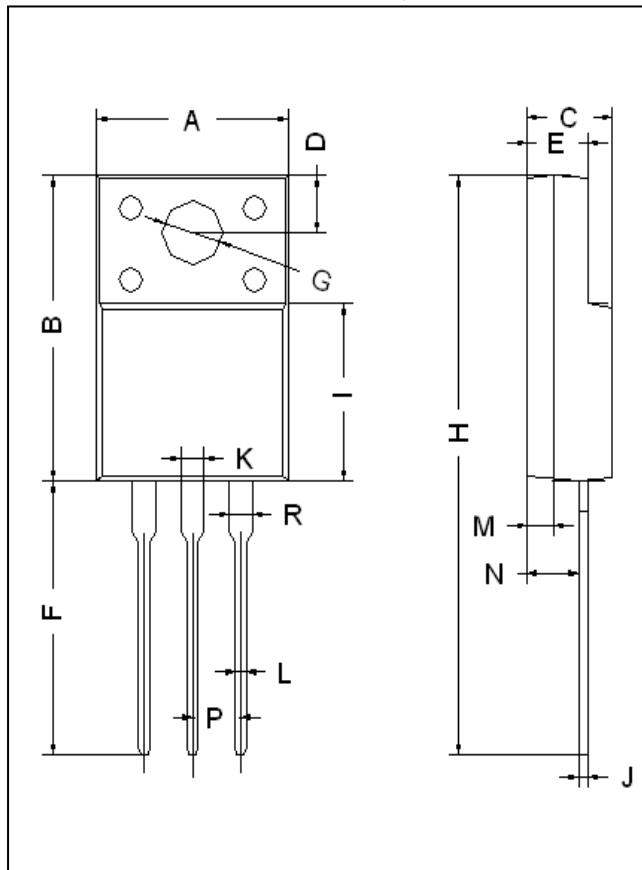
## N-Channel Power MOSFET

## BL15N30F

### PACKAGE OUTLINE

Plastic surface mounted package

ITO-220AB



The diagram illustrates the physical dimensions of the ITO-220AB package. The top view shows the overall footprint with dimensions A, B, D, G, K, R, F, L, P, and J. The side view shows the height H and features C, E, M, N, and J. The table below provides detailed technical dimensions for each parameter.

ITO-220AB		
Dim	Min	Max
A	9.90	10.30
B	14.80	15.20
C	4.50 Typical	
D	2.70 Typical	
E	2.80	3.30
F	13.00	13.60
G	3.2 Typical	
H	28.00	28.60
I	7.90	8.90
J	0.50 Typical	
L	0.70	0.90
M	1.40 Typical	
N	2.60	2.80
P	2.45	2.65
K/R	1.20 Typical	
All Dimensions in mm		